

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	6136	257/532,535,665,734,737,738,780,924.ccls. 438/957,215,613.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/07/08 12:41
S2	998	((bypass or decoupling or decoupled) adj capacitor) and (bump or ball)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/07/08 13:17
S3	70	(257/532,535,665,734,737,738,780,924.ccls. 438/957,215,613.ccls.) and (((bypass or decoupling or decoupled) adj capacitor) and (bump or ball))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/06 15:50
S4	618	((bypass or decoupling or decoupled) adj capacitor) and (bump or ball) and solder	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/07/08 13:18
S5	158	((bypass or decoupling or decoupled) adj capacitor) same (bump or ball) and solder	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/08 15:00
S6	140	((((bypass or decoupling or decoupled) adj capacitor) same (bump or ball) and solder) not ((257/532,535,665,734,737,738,780,924.ccls. 438/957,215,613.ccls.) and (((bypass or decoupling or decoupled) adj capacitor) and (bump or ball))))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/06 15:49
S7	2	"6330164".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/07/08 15:19
S8	17	((((bypass or decoupling or decoupled) adj capacitor) same (bump or ball) and solder) not ((257/532,535,665,734,737,738,780,924.ccls. 438/957,215,613.ccls.) and (((bypass or decoupling or decoupled) adj capacitor) and (bump or ball)))) and (power adj plane) and (ground adj plane)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/06 15:50

S9	14	(257/532,535,665,734,737,738, 780,924.ccls. 438/957,215,613. ccls.) and (((bypass or decoupling or decoupled) adj capacitor) and (bump or ball)) and (power adj plane) and (ground adj plane)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/06 15:50
S10	12	(US-6326677-\$ or US-6184567-\$ or US-6005777-\$ or US-5977640-\$ or US-5798567-\$ or US-5668399-\$ or US-6330164-\$ or US-6130483-\$ or US-5239198-\$).did. or (US-20030110452-\$ or US-20020074653-\$).did. or (JP-2002170920-\$).did.	US-PGPUB; USPAT; JPO	OR	OFF	2003/07/10 11:46
S11	11	(US-6326677-\$ or US-6184567-\$ or US-6005777-\$ or US-5977640-\$ or US-5798567-\$ or US-5668399-\$ or US-6330164-\$ or US-6130483-\$ or US-5239198-\$).did. or (US-20030110452-\$ or US-20020074653-\$).did. or (JP-2002170920-\$).did. and (power adj plane) and (ground adj plane)	US-PGPUB; USPAT; JPO	OR	OFF	2003/07/10 11:46
S12	0	((US-6326677-\$ or US-6184567-\$ or US-6005777-\$ or US-5977640-\$ or US-5798567-\$ or US-5668399-\$ or US-6330164-\$ or US-6130483-\$ or US-5239198-\$).did. or (US-20030110452-\$ or US-20020074653-\$).did. or (JP-2002170920-\$).did.)and (power adj plane) and (ground adj plane)	US-PGPUB; USPAT; JPO	OR	OFF	2003/07/10 11:47
S13	0	((US-6326677-\$ or US-6184567-\$ or US-6005777-\$ or US-5977640-\$ or US-5798567-\$ or US-5668399-\$ or US-6330164-\$ or US-6130483-\$ or US-5239198-\$).did. or (US-20030110452-\$ or US-20020074653-\$).did. or (JP-2002170920-\$).did.)and (power adj plane)	US-PGPUB; USPAT; JPO	OR	OFF	2003/07/10 11:47
S14	1	((US-6326677-\$ or US-6184567-\$ or US-6005777-\$ or US-5977640-\$ or US-5798567-\$ or US-5668399-\$ or US-6330164-\$ or US-6130483-\$ or US-5239198-\$).did. or (US-20030110452-\$ or US-20020074653-\$).did. or (JP-2002170920-\$).did.)and (ground adj plane)	US-PGPUB; USPAT; JPO	OR	OFF	2003/07/10 11:47

S15	4	((US-6326677-\$ or US-6184567-\$ or US-6005777-\$ or US-5977640-\$ or US-5798567-\$ or US-5668399-\$ or US-6330164-\$ or US-6130483-\$ or US-5239198-\$).did. or (US-20030110452-\$ or US-20020074653-\$).did. or (JP-2002170920-\$).did.)and (plane)	US-PGPUB; USPAT; JPO	OR	OFF	2003/07/10 11:47
S16	4	(257/532,535,665,734,737,738, 780,924.ccls. 438/957,215,613. ccls.) and (((bypass or decoupling or decoupled) adj capacitor) and (bump or ball)) and @pd>"20030708"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/10/10 13:09
S17	4	(((bypass or decoupling or decoupled) adj capacitor) same (bump or ball) and solder) not ((257/532,535,665,734,737,738, 780,924.ccls. 438/957,215,613. ccls.) and (((bypass or decoupling or decoupled) adj capacitor) and (bump or ball)))) and (power adj plane) and (ground adj plane) and @pd>"20030708"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/06 15:50
S18	1	(257/532,535,665,734,737,738, 780,924.ccls. 438/957,215,613. ccls.) and (((bypass or decoupling or decoupled) adj capacitor) and (bump or ball)) and (power adj plane) and (ground adj plane) and @pd>"20030708"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/06 15:50

S19	8	((257/532,535,665,734,737,738,780,924.ccls. 438/957,215,613.ccls.) and (((bypass or decoupling or decoupled) adj capacitor) and (bump or ball)) and @pd>"20030708") (((bypass or decoupling or decoupled) adj capacitor) same (bump or ball) and solder) not ((257/532,535,665,734,737,738,780,924.ccls. 438/957,215,613.ccls.) and (((bypass or decoupling or decoupled) adj capacitor) and (bump or ball))) and (power adj plane) and (ground adj plane) and @pd>"20030708") ((257/532,535,665,734,737,738,780,924.ccls. 438/957,215,613.ccls.) and (((bypass or decoupling or decoupled) adj capacitor) and (bump or ball)) and (power adj plane) and (ground adj plane) and @pd>"20030708")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/10/10 13:10
S20	2	"20020017700".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/05 14:55
S21	86	(((bypass or decoupling or decoupled) adj capacitor) same (bump or ball) and solder) not ((257/532,535,665,734,737,738,780,924.ccls. 438/957,215,613.ccls.) and (((bypass or decoupling or decoupled) adj capacitor) and (bump or ball))) and @pd>"20031010"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/06 15:50
S22	20	(((bypass or decoupling or decoupled) adj capacitor) same (bump or ball) and solder) not ((257/532,535,665,734,737,738,780,924.ccls. 438/957,215,613.ccls.) and (((bypass or decoupling or decoupled) adj capacitor) and (bump or ball))) and (power adj plane) and (ground adj plane) and @pd>"20031010"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/06 15:50
S23	8	(257/532,535,665,734,737,738,780,924.ccls. 438/957,215,613.ccls.) and (((bypass or decoupling or decoupled) adj capacitor) and (bump or ball)) and (power adj plane) and (ground adj plane) and @pd>"20031010"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/06 15:50

S24	43	(257/532,535,665,734,737,738, 780,924.ccls. 438/957,215,613. ccls.) and (((bypass or decoupling or decoupled) adj capacitor) and (bump or ball)) and @pd>"20031010"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/06 15:50
S25	20	(((bypass or decoupling or decoupled) adj capacitor) same (bump or ball) and solder) not ((257/532,535,665,734,737,738, 780,924.ccls. 438/957,215,613. ccls.) and (((bypass or decoupling or decoupled) adj capacitor) and (bump or ball))) and (power adj plane) and (ground adj plane) and @pd>"20031010"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/06 15:50
S26	8	(257/532,535,665,734,737,738, 780,924.ccls. 438/957,215,613. ccls.) and (((bypass or decoupling or decoupled) adj capacitor) and (bump or ball)) and (power adj plane) and (ground adj plane) and @pd>"20031010"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/06 15:51
S27	129	S21 S22 S23 S24 S25 S26	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/06 15:51
S28	3	"10/152524"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/08 14:58
S29	308	((bypass or decoupling or decoupled) adj capacitor) same (bump or ball) and solder	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/08 15:04
S30	188	((bypass or decoupling or decoupled) adj capacitor) same (bump or ball) and solder and "257"/\$.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/08 15:01
S31	115	((bypass or decoupling or decoupled) adj capacitor) same (bump or ball) and solder and "257"/\$.ccls.	USPAT	OR	ON	2006/02/13 12:31
S32	4	((bypass or decoupling or decoupled) adj capacitor) same (bump or ball) and solder and "257"/\$.ccls. and vcc and vss	USPAT	OR	ON	2006/02/08 15:04

S33	16	((bypass or decoupling or decoupled) adj capacitor) same (bump or ball) and solder and vcc and vss	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/08 15:04
S34	32	((bypass or decoupling or decoupled) adj capacitor) same (bump or ball) and solder and (257/532,535,665,734,737,738, 780,924.ccls. 438/957,215,613. ccls.)	USPAT	OR	ON	2006/02/13 12:38
S35	0	"20030218235".pn.	USPAT	OR	ON	2006/02/13 12:38
S36	0	"200300218235".pn.	USPAT	OR	ON	2006/02/13 12:38
S37	1	"20030218235".pn.	US-PGPUB; USPAT	OR	ON	2006/02/13 12:39